

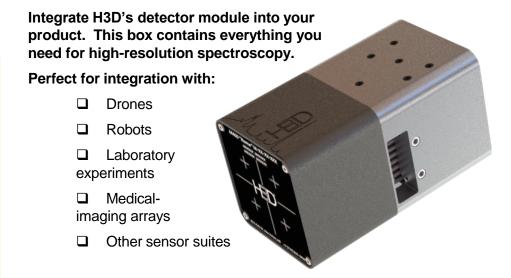
# Custom Integrable Detector Module

## **Features**

- ✓ Fast and highly portable spectrometer
- ✓ Option for ≤0.8% FWHM energy resolution at 662 keV and interaction-by-interaction resolution of ≤0.65% FWHM
- ✓ Ready to use in less than 60 s
- √ Rapidly identifies gamma-ray sources
- ✓ Industry-leading efficiency with up to >29 cm³ pixelated CZT
- ✓ Real-time spectroscopy and ID
- ✓ Discrimination between background and sources of interest in less than 20 s
- ✓ Single USB connection for power and control
- ✓ Wireless, Ethernet, or USB communication
- ✓ Option for gamma-ray imaging from 250 keV to 3 MeV
- ✓ Option to synchronize data collection with other radiation detectors for coincidence detection



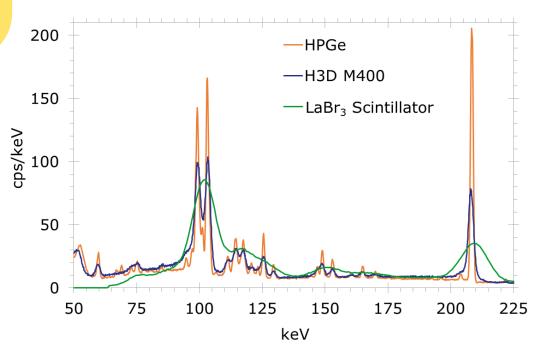
The M400 system mounted on a drone.



Containing the most advanced room-temperature semiconductor technology to achieve spectroscopic performance competitive with cryogenically cooled detectors, the detector module has:

- □ Compact and light-weight size
- □ Fast startup
- Excellent energy resolution
- Low power

Contact H3D to create a custom solution for your application.



#### Any options can be combined, except as noted.

## **High-Resolution Option (M400+)**

Improve energy resolution to ≤0.8% FWHM at 662 keV (coincident interactions combined) and ≤0.65% FWHM at 662 keV (coincident interactions separated)

### **Lower Efficiency Options**

#### M200

Crystal Volume:  $>9.5 \text{ cm}^3$ Anode Pixelation: 2 x 11 x 11 Sensitivity: Detect in <44 s

#### M100

Crystal Volume:  $>4.5 \text{ cm}^3$ Anode Pixelation: 1 x 11 x 11 Sensitivity: Detect in <88 s

### Extra-High-Efficiency Option (M400-15)

Increase crystal volume to >29 cm<sup>3</sup>. Also available as a higher-resolution M400+-15 with no resolution guarantee.

# **M400 Base Specifications**

Note: Custom designs also available

4.0 in x 2.25 in x 2.25 in Dimensions: (10.2 cm x 5.7 cm x 5.7 cm)

Weight: 1.3 lbs (0.6 kg) Battery: Optional add-on box

Power Input: 5 V, <6 W, USB-C (option for other connectors) Startup & Operating Temp.: -20° C to 50° C (-4° F to 122° F) with fan enabled

-10° C to 35° C (14° F to 95° F) with fan disabled

Startup Time: <60 s

Energy Resolution: ≤1.1% FWHM at 662 keV (coincident interactions combined)

≤0.9% FWHM at 662 keV (coincident interactions separated)

Sensitivity: Detects 10- $\mu$ Ci <sup>137</sup>Cs at 1 m (~3  $\mu$ R/hr) in < 22 s

(in natural background)

Spectroscopy Range: 50 keV to 3 MeV

Crystal Volume: >19 cm<sup>3</sup> CZT (CdZnTe)

Anode Pixelation: 4 x 11 x 11

<0.5 mm (≥140 keV) Spatial Resolution:

1 rem/hr (10 mSv/hr) bare-137Cs equivalent Count-Rate Limit: Maximum Event Rate: 75 kcps at <0.5-mm spatial resolution 150 kcps at <2-mm spatial resolution

FPGA-level architecture Coincidence:

**Communication Options:** USB to computer **USB** to Ethernet

Wireless communication interfaces available

Data API Options: Real-time spectrum

Event total energy, each interaction energy, and time stamp

## **Compton Imaging Option (M400i)**

Image Energy Range: 250 keV to 3 MeV

Field of View: 4п (360°) omnidirectional

±1° source localization for all 4п (real time) Angular Precision: Angular Resolution: ~30° FWHM for all 4п (real time; >250 keV) ~20° FWHM for all 4π (post processing; >250 keV)

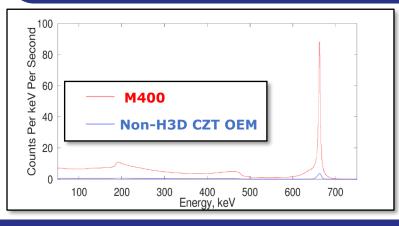
Localize point source of  $^{137}$ Cs producing  $\sim 3 \mu R/hr$  in < 90 s

Sensitivity: Data API Options: Each interaction 3D position (x, y, z)

## Optical Camera and Imaging Option (M400iC)

All specifications of M400i, and...

Optical Field of View: >162° horizontal, >122° vertical; full color Optical Registration: ±2° to radiation image in front 90° × 90°



Spectral comparison between **H3D M400** and non-**H3D CZT ΟΕΜ.** (10 μCi <sup>137</sup>Cs, 5 cm)









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